PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
NORIAKI FUKUDA	05/26/2015
SHOHEI SANADA	05/26/2015
KATSUMASA YAMAMOTO	05/26/2015

RECEIVING PARTY DATA

Name:	SUMITOMO SEIKA CHEMICALS CO., LTD.
Street Address:	346-1, MIYANISHI, HARIMA-CHO, KAKO-GUN
City:	HYOGO
State/Country:	JAPAN
Postal Code:	675-0145

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14438499

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	20162.0122USWO	
NAME OF SUBMITTER:	DOUGLAS P. MUELLER	
SIGNATURE:	/Douglas P. Mueller/	
DATE SIGNED:	06/09/2015	

Total Attachments: 2

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PATENT 503342698 REEL: 035810 FRAME: 0993

and

Attorney Docket No.: 20162.0122USWO

Inventor Declaration

As the below named inventor, I hereby declare that:

As the below handed inventor, I hereby declare that:
This declaration is directed to:
☐ The attached application entitled or ☐ United States application Serial Number or or PCT International application number PCT/JP2013/078057 filed on October 16, 2013 ☐ amended on (if applicable) entitled: SILICONE RESIN COMPOSITION, CURED SILICONE RESIN, AND SEALED OPTICAL SEMICONDUCTOR ELEMENT
I believe I am the original inventor or an original joint inventor of a claimed invention in the application for which this declaration is being submitted.
The application for which this declaration is being submitted was made or was authorized to be made by me.
37 CFR 1.63(c) states that a person may not execute a declaration for an application unless that person has reviewed and understands the contents of the application, including the claims, and is aware of the duty to disclose to the USPTO all information known to the person to be material to patentability as defined in 37 CFR 1.56.
I hereby acknowledge that any willful false statement made herein is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.
Assignment
WHEREAS,
1. Noriaki FUKUDA with a mailing address of c/o Sumitomo Seika Chemicals Co., Ltd., 346-1, Miyanishi, Harima-cho, Kako-gun, Hyogo 675-0145, Japan
2. Shohei SANADA with a mailing address of c/o Sumitomo Seika Chemicals Co., Ltd., 346-1, Miyanishi, Harima-cho, Kako-gun, Hyogo 675-0145, Japan
3. Katsumasa YAMAMOTO with a mailing address of c/o Sumitomo Seika Chemicals Co., Ltd., 346-1, Miyanishi, Harima-cho, Kako-gun, Hyogo 675-0145, Japan
(hereinafter called "THE UNDERSIGNED") has made an invention and has executed an application for Letters Patent of the United States for this invention which was filed on , entitled SILICONE RESIN COMPOSITION, CURED SILICONE RESIN, AND SEALED OPTICAL SEMICONDUCTOR ELEMENT, and which has been given application serial number;

PATENT REEL: 035810 FRAME: 0994 WHEREAS Sumitomo Seika Chemicals Co., Ltd. (hereinafter "ASSIGNEE") a corporation organized under the laws of Japan and having an office and place of business at 346-1, Miyanishi, Harima-cho, Kako-gun, Hyogo 675-0145, Japan wishes to acquire the entire right, title and interest in and to said invention and patent application and any Letters Patent to be obtained therefor;

NOW, THEREFORE, for and in consideration of the sum of One Dollar (\$1.00) and other good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, THE UNDERSIGNED hereby sell, assign, and transfer to the ASSIGNEE, its successors, legal representative and assigns, the entire right, title and interest for the United States in and to the invention disclosed in said application, and in and to said application, as well as to all divisions, continuations, or renewals thereof, all Letters Patent which may be granted therefrom, and all reissues or extensions of such patents, and THE UNDERSIGNED hereby authorize and request the Commissioner of Patents of the United States to issue all Letters Patent for said invention to the ASSIGNEE of the entire right, title and interest in and to the same, in accordance with the terms of this instrument.

THE UNDERSIGNED hereby agree that THE UNDERSIGNED, their executors and legal representatives will make, execute and deliver (without charge but at the expense of the ASSIGNEE) any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said ASSIGNEE, its successors and representatives all facts known to the UNDERSIGNED relating to said invention and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable to vest the ASSIGNEE, it successors or assigns, the entire right, title and interest in and to the said invention, patent applications, Letters Patent, rights, titles, benefits, privileges, and advantages hereby sold, assigned and conveyed, or intended so to be.

THE UNDERSIGNED represent and agree with said ASSIGNEE, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by the UNDERSIGNED, and that full right to convey the same as herein expressed is possessed by the UNDERSIGNED.

IN TESTIMONY WHEREOF, THE UNDERSIGNED have hereunto set their hand on the dates indicated below.

Notialei hukuda.	MAY, 26, 2015 Date	
1. Noriaki FUKUDA		
Shohei Sanada	MAY. 26.2015	
2. Shohei SANADA	Date	
Katsumasa Yama moto 3. Katsumasa YAMAMOTO	MAY. 26.2015	
3. Katsumasa YAMAMOTO	Date	